

## MMSZ4689

### General Description

Half watt, General purpose, Medium Current Surface Mount Zener in the SOD-123 package. The SOD-123 package has the same footprint as the glass mini-melf (LL-34) package & provides a convenient alternative to the Leadless package.

### Features

- Compact surface mount with same footprint as mini-melf
- 500mW rating on FR-4 or FR-5 board.
- Class 3 ESD rating (>16kV) per Human Body Model

### Ordering

- 7 inch reel (178mm); 8mm Tape; 3,000 units per reel.

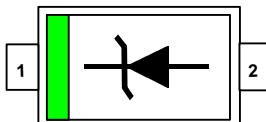
### Absolute Maximum Ratings (note 1) $T_A=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
$T_{\text{STG}}$	Storage Temperature	-55 ~ 150	$^{\circ}\text{C}$
$T_J$	Maximum Junction Temperature	-55 ~ 150	$^{\circ}\text{C}$
$P_D$	Total Power Dissipation at $25^{\circ}\text{C}$ Derate above $25^{\circ}\text{C}$	500 6.7	mW mW/ $^{\circ}\text{C}$
$R_{\text{QJA}}$	Thermal Resistance Junction to Ambient	340	$^{\circ}\text{C/W}$
$R_{\text{QJL}}$	Thermal Resistance Junction to Lead	150	$^{\circ}\text{C/W}$
$\Delta V_Z$	Maximum Voltage Change (note 2)	970	mV
Lead Solder Temperature (Max 10 second duration)		260	$^{\circ}\text{C}$
Nominal Zener Voltage ( $V_Z$ ) at 50 $\mu\text{A}$		5.1	V

Note 1: These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Note 2: Voltage change is equal to the difference between  $V_Z$  at 100 $\mu\text{A}$  and  $V_Z$  at 10 $\mu\text{A}$ .

Top Mark: CU  
1: Cathode  
2: Anode



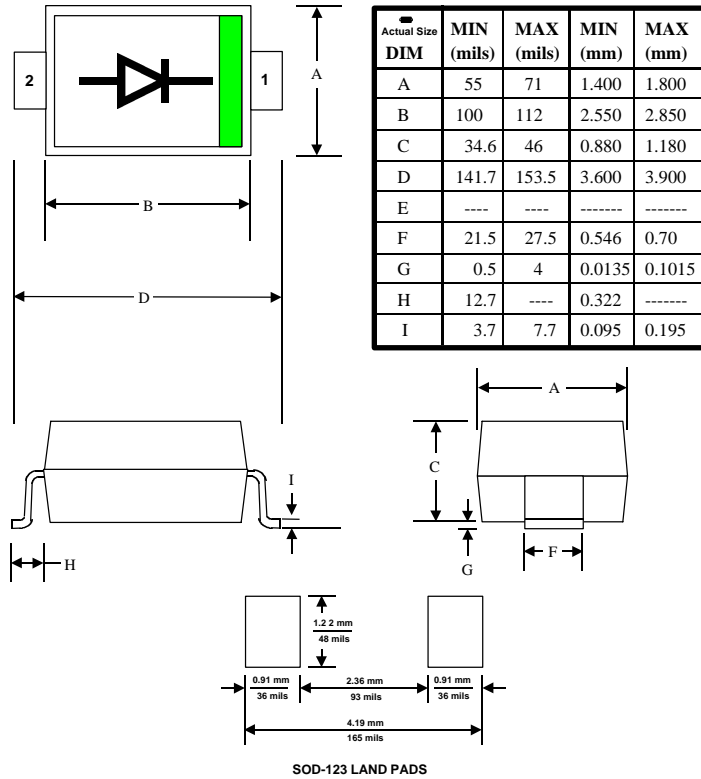
### Electrical Characteristics $T_A=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Characteristics	Test Conditions	Min.	Max.	Units
$V_Z$	Zener Voltage	$I_{ZT} = 50\mu\text{A}$ D.C	4.85	5.36	V
$I_R$	Reverse Leakage	$V_R = 3.0\text{V}$		10	$\mu\text{A}$
$V_F$	Forward Voltage	$I_F = 10\text{mA}$		900	mV
$\Delta V_Z$	Delta Zener Voltage (Note 2)	$I_{ZT} = 100\mu\text{A}$ to 10 $\mu\text{A}$		970	mV

# SOD-123 PACKAGE

PACKAGE CODE = (D6)  
Fairchild Semiconductor's Criteria

Corrected March 11, 1998



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